

Features

- CRM(CQ) Super_Junction technology
- Much lower $R_{on} \cdot A$ performance for On-state efficiency
- Much lower FOM for fast switching efficiency

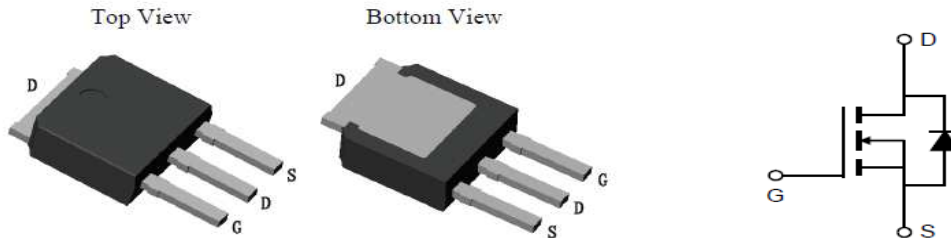
Applications

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply

Product Summary

VDS	700V
$R_{DS(on)}_{typ}$	0.78Ω
I_D	6A

100% Avalanche Tested


Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRJH900N70G2	-	TO-251	Tube	N/A	N/A	70pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	700	V
Continuous drain current $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_D	6 4.0	A
Pulsed drain current ($T_C = 25^\circ\text{C}$, t_p limited by T_{jmax})	$I_{D\ pulse}$	25	A
Avalanche energy, single pulse ($L=30\text{mH}$, $R_g=30\Omega$)	E_{AS}	60	mJ
Gate-Source voltage	V_{GS}	± 30	V
Power dissipation ($T_C = 25^\circ\text{C}$)	P_{tot}	71	W
Operating junction and storage temperature	T_j, T_{stg}	-55...+150	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal resistance, junction – case. Max	R_{thJC}	1.76	°C/W
Thermal resistance, junction – ambient. Max	R_{thJA}	134	

Electrical Characteristic (at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV_{DSS}	700	-	-	V	$V_{GS}=0V, I_D=250\mu A$
Gate threshold voltage	$V_{GS(th)}$	3	3.5	4	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	$V_{DS}=700V, V_{GS}=0V$ $T_C=25^\circ C$ $T_C=150^\circ C$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=\pm 30V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	0.78	0.90	Ω	$V_{GS}=10V, I_D=3A,$ $T_C=25^\circ C$ $T_C=150^\circ C$
Transconductance	g_{fs}	-	5	-	S	$V_{DS}=20V, I_D=3A$

Dynamic Characteristic

Input Capacitance	C_{iss}	-	327	-	pF	$V_{GS}=0V, V_{DS}=100V, f=1MHz$
Output Capacitance	C_{oss}	-	25	-		
Reverse Transfer Capacitance	C_{rss}	-	23	-		
Gate Total Charge	Q_G	-	11	-	nC	$V_{GS}=10V, V_{DS}=480V, I_D=3A,$ $f=1MHz$
Gate-Source charge	Q_{gs}	-	2.5	-		
Gate-Drain charge	Q_{gd}	-	4.6	-		
Turn-on delay time	$t_{d(on)}$	-	12.6	-	ns	$T_j=25^\circ C, V_{GS}=10V, I_D=3A,$ $V_{DS}=400V, R_g=25\Omega$
Rise time	t_r	-	13.4	-		
Turn-off delay time	$t_{d(off)}$	-	50	-		
Fall time	t_f	-	61	-		
Gate resistance	R_G	-	9.0	-	Ω	$V_{GS}=0V, V_{DS}=0V, f=1MHz$

Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V_{SD}	0.5	0.84	1	V	$V_{GS}=0V, I_{SD}=3A$
Body Diode Reverse Recovery Time	t_{rr}	-	185	-	ns	$I_{sd}=3A$ $dI/dt=100A/us, V_{ds}=100V$
Body Diode Reverse Recovery Charge	Q_{rr}	-	1.47	-	uC	

Typical Performance Characteristics

Fig 1. Output Characteristics (Tj=25°C)

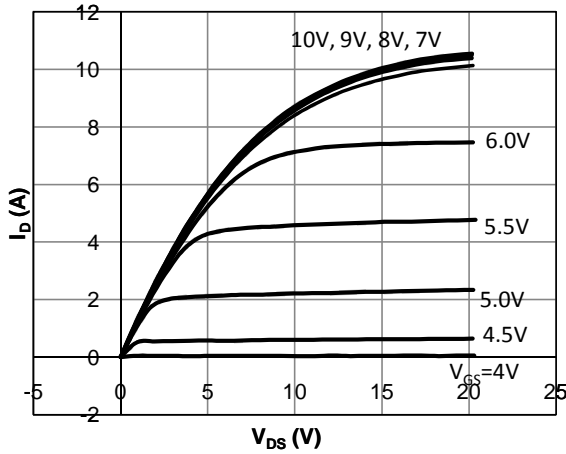


Fig 2. Output Characteristics (Tj=150°C)

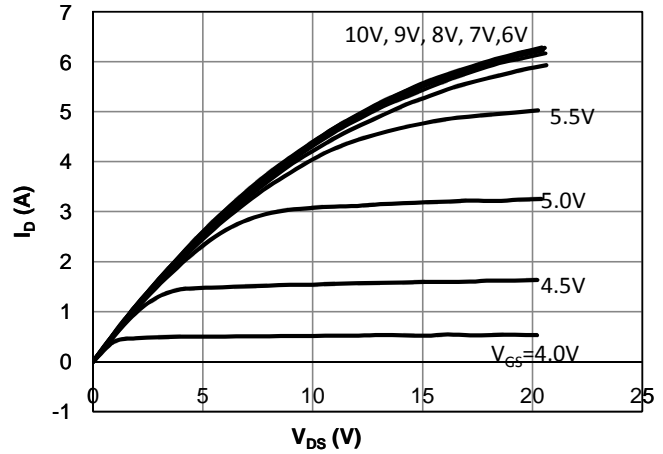


Fig 3: Transfer Characteristics

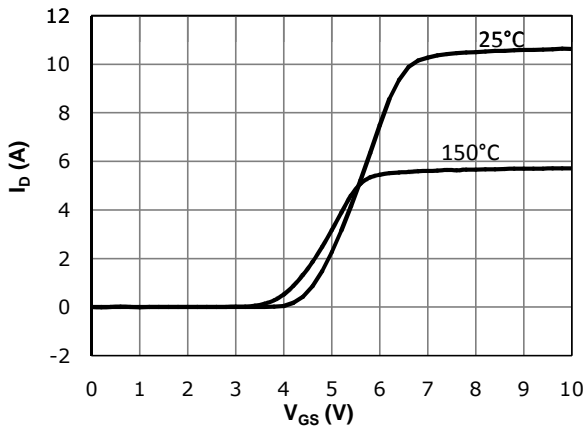


Fig 4: VTH Vs Tj Temperature Characteristics

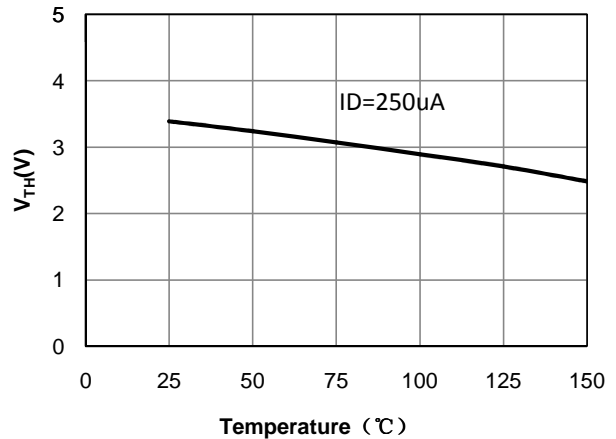


Fig 5: Rds(on) Vs Ids Characteristics(Tc=25°C)

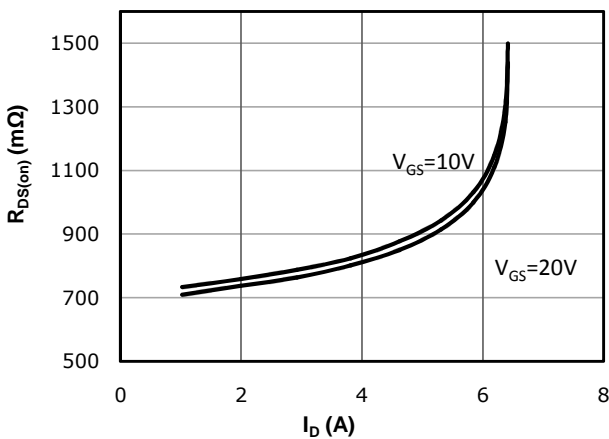


Fig 6: Rds(on) vs. Temperature

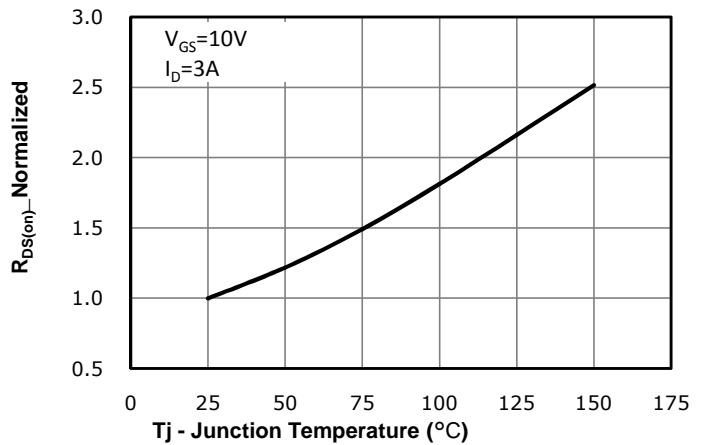


Fig 7: BVdss vs. Temperature

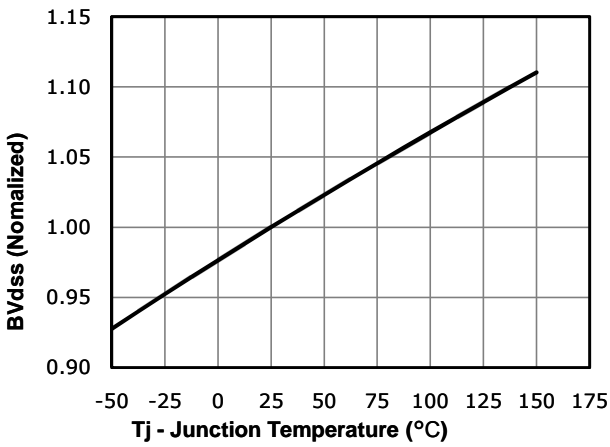


Fig 8: Rds(on) vs Gate Voltage

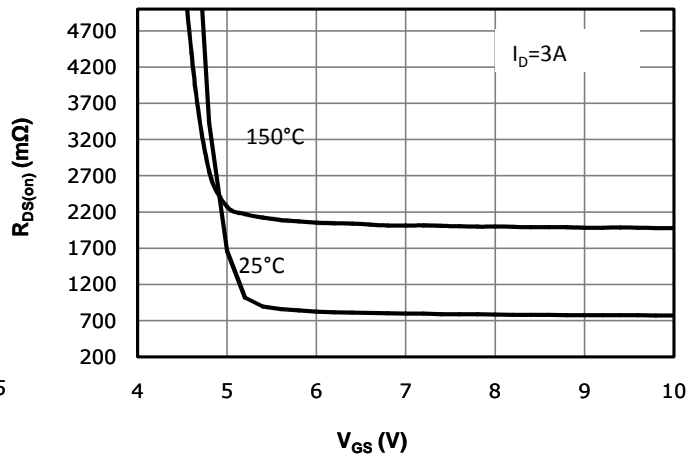


Fig 9: Body-diode Forward Characteristics

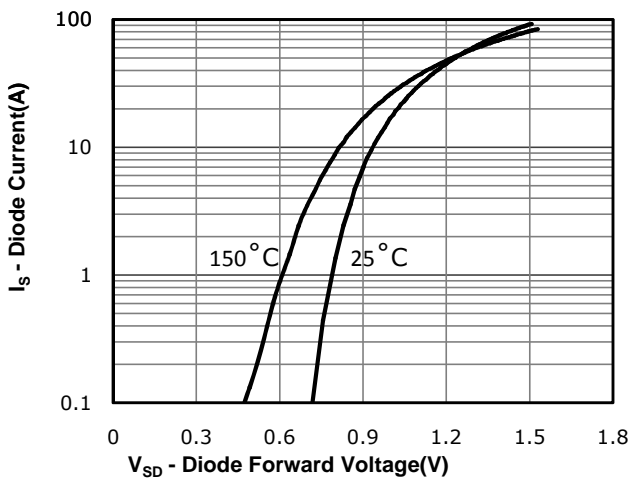


Fig 10: Gate Charge Characteristics

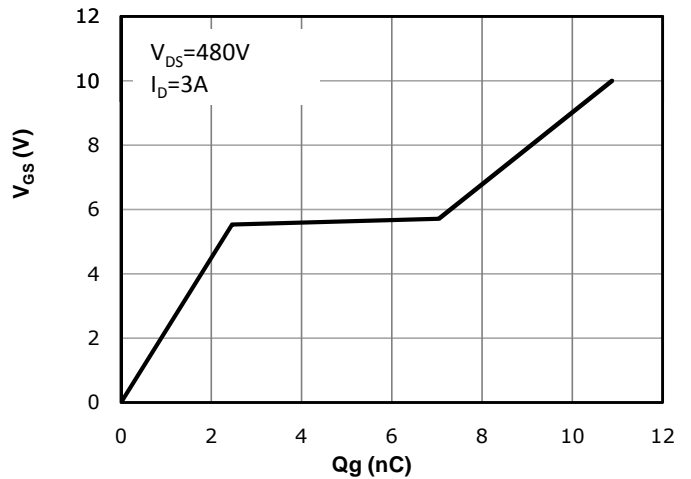


Fig 11: Capacitance Characteristics

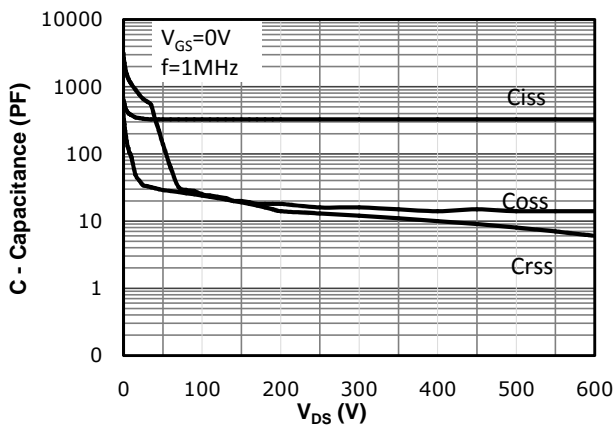


Fig 12: Safe Operating Area

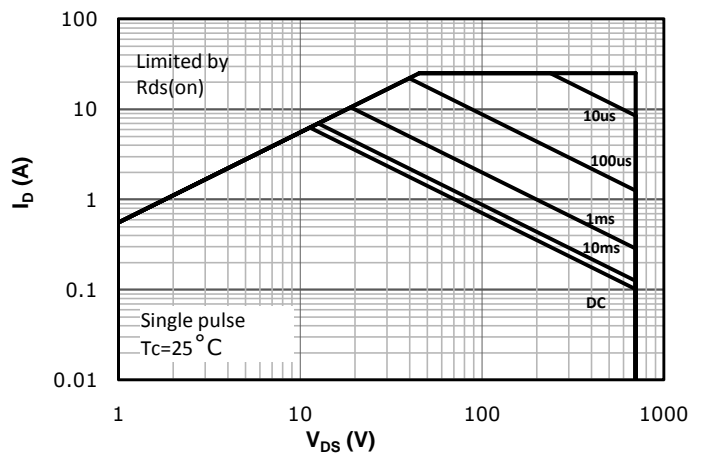
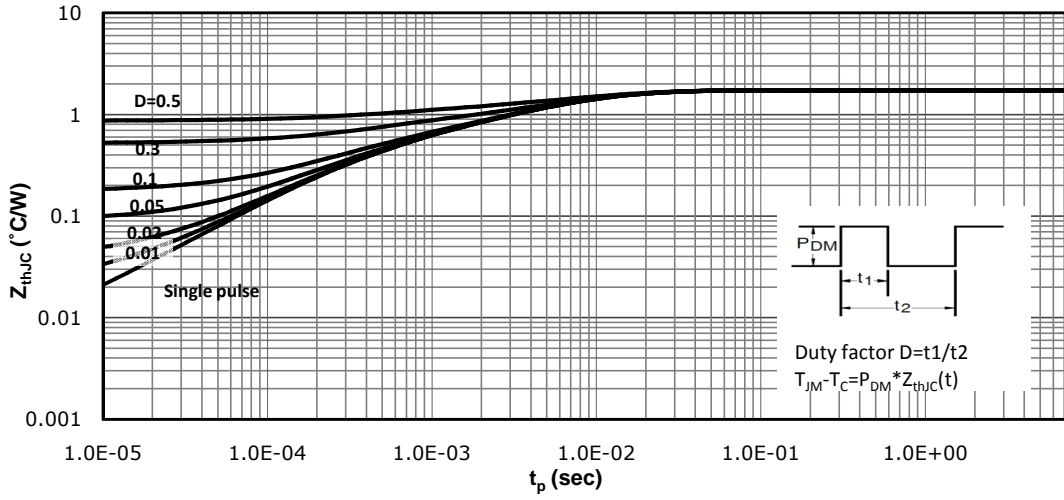
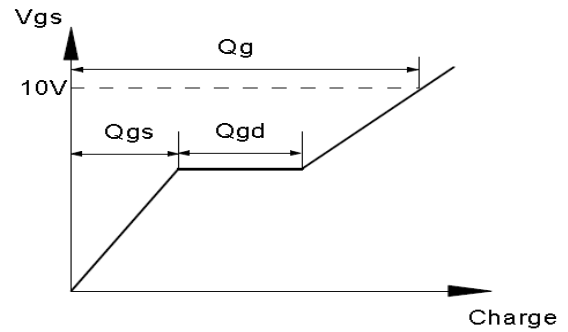
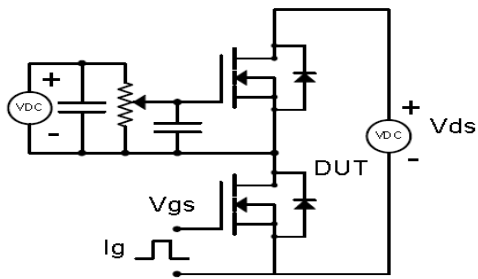


Fig 13: Max. Transient Thermal Impedance

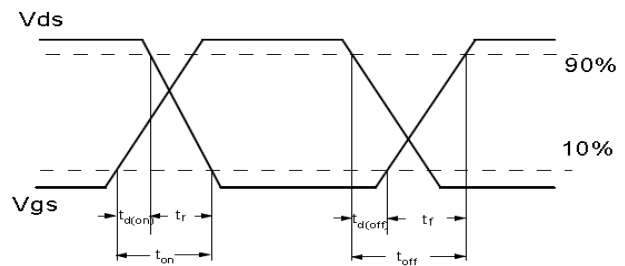
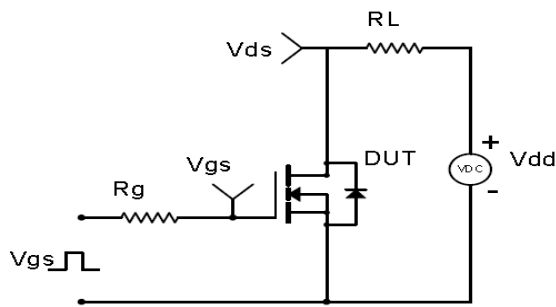


Test Circuit & Waveform

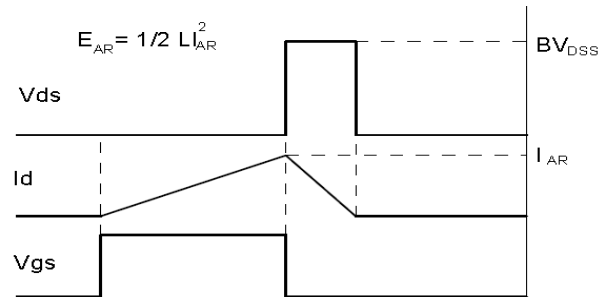
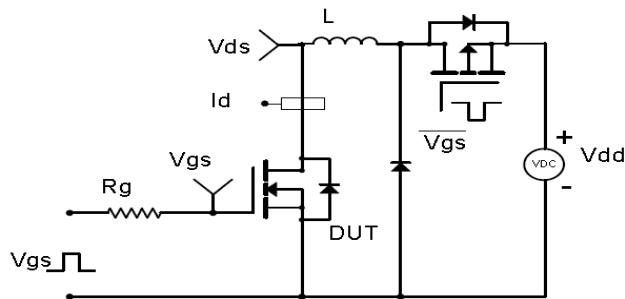
Gate Charge Test Circuit & Waveform



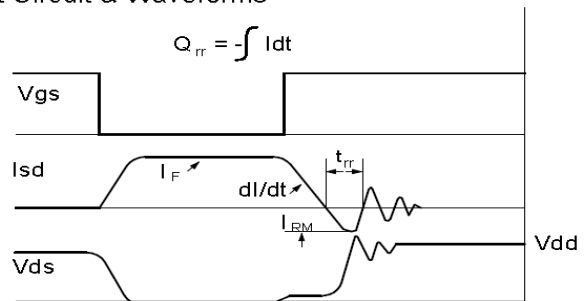
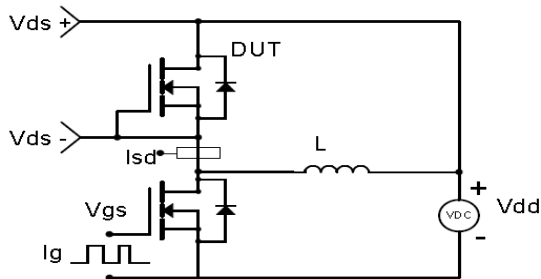
Resistive Switching Test Circuit & Waveforms



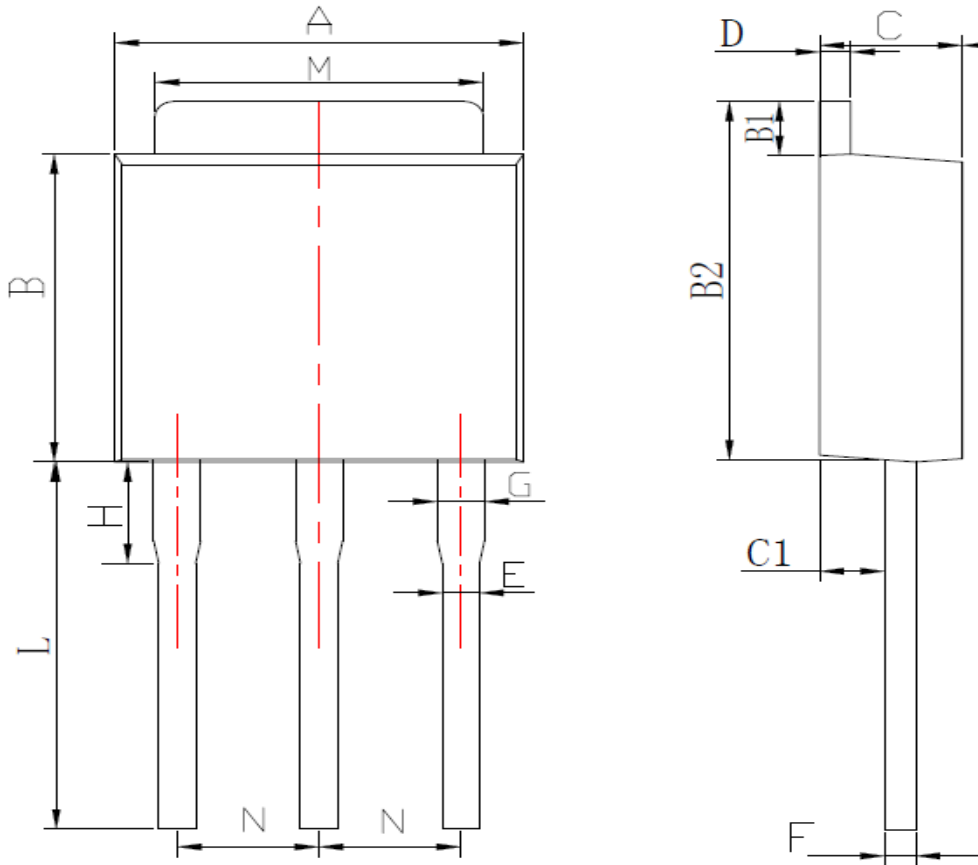
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: TO-251



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	6.30	6.90	0.248	0.272
B	5.20	6.30	0.205	0.248
B1	0.70	1.30	0.028	0.051
B2	6.80	7.40	0.268	0.291
C	2.10	2.50	0.083	0.098
C1	0.90	1.20	0.035	0.047
D	0.30	0.60	0.012	0.024
E	0.50	0.86	0.020	0.034
F	0.30	0.60	0.012	0.024
G	0.70	1.00	0.028	0.039
H	1.40	2.40	0.055	0.094
L*	9.00	9.80	0.354	0.386
M	5.10	5.50	0.201	0.217
N	2.09	2.49	0.082	0.098

*adjustable

Revision History

Revision	Date	Major changes
1.0	2020-7-23	Release of first version

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

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